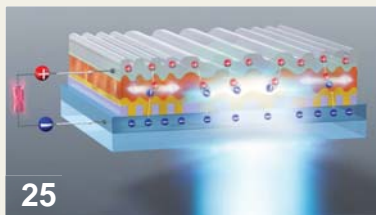




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Foldable AMOLED display (page 55)

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